Old Company Name in Catalogs and Other Documents

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April 1st, 2010 Renesas Electronics Corporation

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DATA SHEET



MOS FIELD EFFECT TRANSISTOR NP84N04EHE, NP84N04KHE NP84N04CHE, NP84N04DHE, NP84N04MHE, NP84N04NHE

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

<R> ORDERING INFORMATION

| PART NUMBER | LEAD PLATING | PACKING | ₩ PACKAGE | | |
|----------------------------|---------------|------------------|-----------------------------------|--|--|
| NP84N04EHE-E1-AY Note1, 2 | | | TO 000 (MD 057 I) to 1.4 c | | |
| NP84N04EHE-E2-AY Note1, 2 | Dura Ca /Tia) | Tana 200 n/raal | TO-263 (MP-25ZJ) typ. 1.4 g | | |
| NP84N04KHE-E1-AY Note1 | Pure Sn (Tin) | Tape 800 p/reel | TO 2022 (MD 25710) have 4.5 m | | |
| NP84N04KHE-E2-AY Note1 | | | TO-263 (MP-25ZK) typ. 1.5 g | | |
| NP84N04CHE-S12-AZ Note1, 2 | Sn-Ag-Cu | | TO-220 (MP-25) typ. 1.9 g | | |
| NP84N04DHE-S12-AY Note1, 2 | | Tuba CO a thicka | TO-262 (MP-25 Fin Cut) typ. 1.8 g | | |
| NP84N04MHE-S18-AY Note1 | Pure Sn (Tin) | Tube 50 p/tube | TO-220 (MP-25K) typ. 1.9 g | | |
| NP84N04NHE-S18-AY Note1 | | -0 | TO-262 (MP-25SK) typ. 1.8 g | | |

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Not for new design

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance

 $R_{DS(on)} = 5.2 \text{ m}\Omega$ MAX. (Vgs = 10 V, ID = 42 A)

• Low input capacitance

Ciss = 4410 pF TYP.

Built-in gate protection diode



(TO-220)

(TO-262)



(TO-263)



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ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C)

| Drain to Source Voltage (Vgs = 0 V) | VDSS | 40 | V |
|---|-----------------------|-------------|----|
| Gate to Source Voltage (VDS = 0 V) | Vgss | ±20 | V |
| Drain Current (DC) (Tc = 25°C) Note1 | ID(DC) | ±84 | Α |
| Drain Current (Pulse) Note2 | I _{D(pulse)} | ±336 | Α |
| Total Power Dissipation (Tc = 25°C) | Рт | 200 | W |
| Total Power Dissipation (T _A = 25°C) | Pτ | 1.8 | W |
| Channel Temperature | Tch | 175 | °C |
| Storage Temperature | Tstg | -55 to +175 | °C |
| Single Avalanche Current Note3 | las | 84/61/22 | Α |
| Single Avalanche Energy Note3 | Eas | 70/372/484 | mJ |

Notes 1. Calculated constant current according to MAX. allowable channel temperature.

- **2.** PW \leq 10 μ s, Duty cycle \leq 1%

THERMAL RESISTANCE

3. Starting T_{ch} = 25°C, V_{DD} = 20 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V (see **Figure 4.**)

RMAL RESISTANCE

nel to Case Thermal Resistance Rth(ch-C) 0.75 °C/W

nel to Ambient Thermal Resistance Rth(ch-A) 83.3 °C/W EOL announced Channel to Case Thermal Resistance Channel to Ambient Thermal Resistance

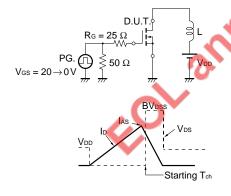


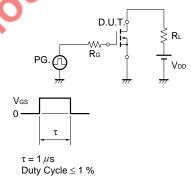
ELECTRICAL CHARACTERISTICS (TA = 25°C)

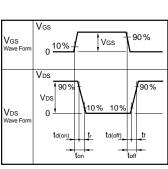
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------|----------------------|---|----------|------|------|------|
| Zero Gate Voltage Drain Current | IDSS | V _{DS} = 40 V, V _{GS} = 0 V | | | 10 | μΑ |
| Gate Leakage Current | Igss | V _{GS} = ±20 V, V _{DS} = 0 V | | | ±10 | μΑ |
| Gate to Source Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 2.0 | 3.0 | 4.0 | V |
| Forward Transfer Admittance | y fs | V _{DS} = 10 V, I _D = 42 A | 20 | 47 | | S |
| Drain to Source On-state Resistance | R _{DS(on)} | V _{GS} = 10 V, I _D = 42 A | | 4.6 | 5.2 | mΩ |
| Input Capacitance | Ciss | V _{DS} = 25 V, | | 4410 | 6620 | pF |
| Output Capacitance | Coss | V _{GS} = 0 V, | | 950 | 1430 | pF |
| Reverse Transfer Capacitance | Crss | f = 1 MHz | | 490 | 890 | pF |
| Turn-on Delay Time | t _{d(on)} | V _{DD} = 20 V, I _D = 42 A, | | 36 | 79 | ns |
| Rise Time | tr | Ves = 10 V, | * | 25 | 62 | ns |
| Turn-off Delay Time | t _{d(off)} | $R_G = 1 \Omega$ | C | 77 | 150 | ns |
| Fall Time | t f | | 3 | 28 | 69 | ns |
| Total Gate Charge | Q _G | V _{DD} = 32 V, | | 87 | 130 | nC |
| Gate to Source Charge | Qgs | V _{GS} = 10 V, | | 20 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = 84 A | | 32 | | nC |
| Body Diode Forward Voltage | V _F (S-D) | IF = 84 A, VGS = 0 V | | 1.0 | | V |
| Reverse Recovery Time | trr | IF = 84 A, VGS = 0 V, | | 49 | | ns |
| Reverse Recovery Charge | Qrr | di/dt = 100 A/μs | | 60 | | nC |

TEST CIRCUIT 1 AVALANCHE CAPABILITY

TEST CIRCUIT 2 SWITCHING TIME







TEST CIRCUIT 3 GATE CHARGE

$$\begin{array}{c|c} D.U.T. \\ \hline \\ IG = 2 \text{ mA} \\ \hline \\ VOD \\ \hline \end{array}$$

TYPICAL CHARACTERISTICS (TA = 25°C)

Figure1. DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

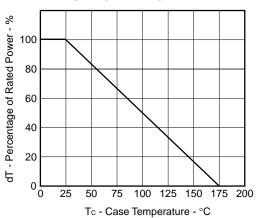


Figure 3. FORWARD BIAS SAFE OPERATING AREA

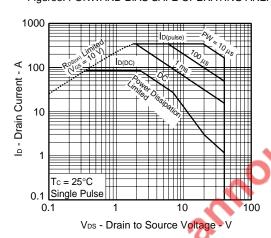


Figure 2. TOTAL POWER DISSIPATION vs. CASE TEMPERATURE

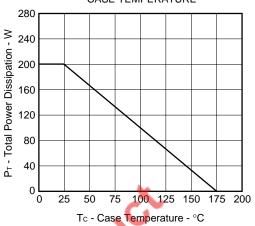


Figure 4. SINGLE AVALANCHE ENERGY DERATING FACTOR

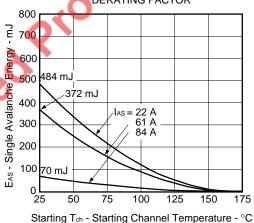
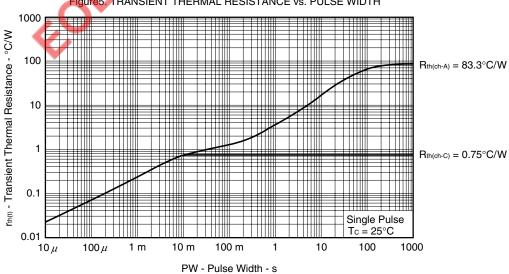
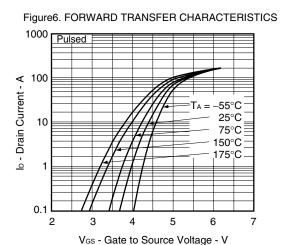
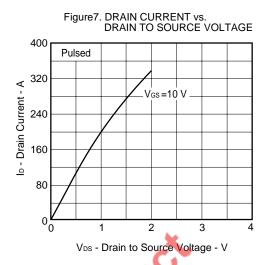
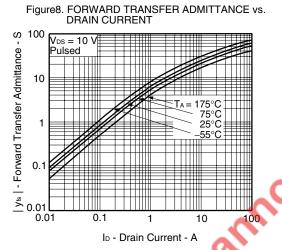


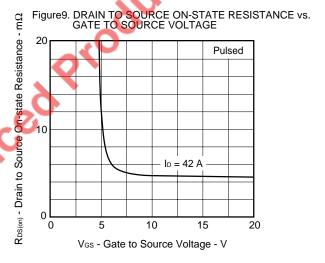
Figure5. TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

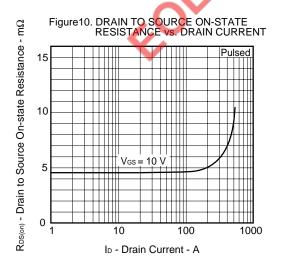


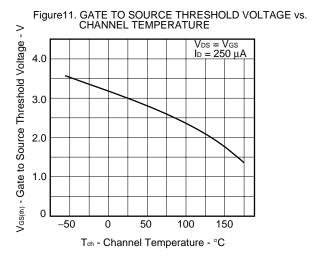




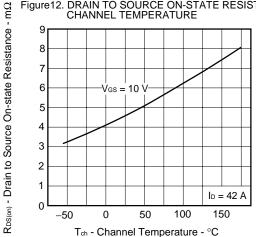


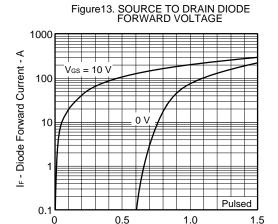






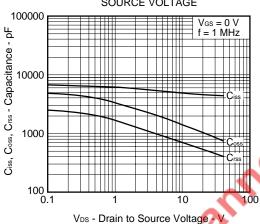


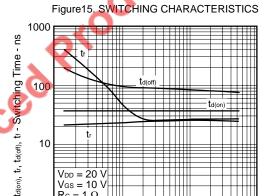




V_{F(S-D)} - Source to Drain Voltage - V

Figure 14. CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE





 $R_G = 1 \Omega$

0.1

Figure 16. REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT

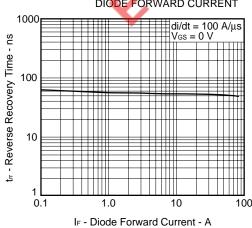
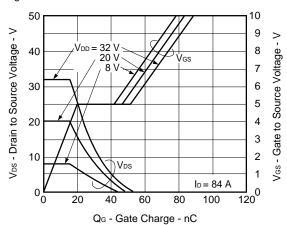


Figure 17. DYNAMIC INPUT/OUTPUT CHARACTERISTICS

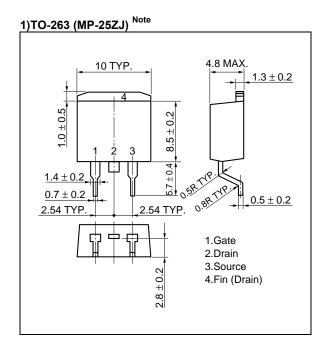
ID - Drain Current - A

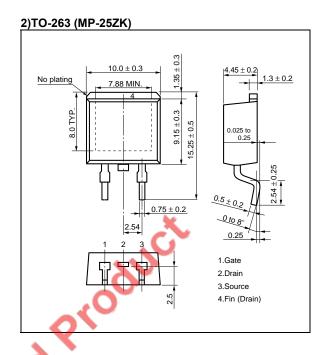
10

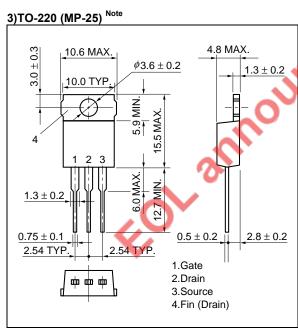
100

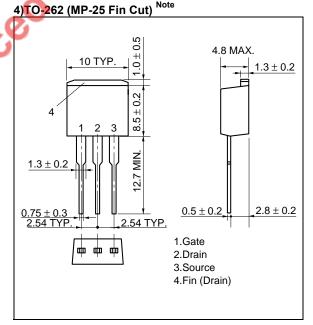


<R> PACKAGE DRAWINGS (Unit: mm)

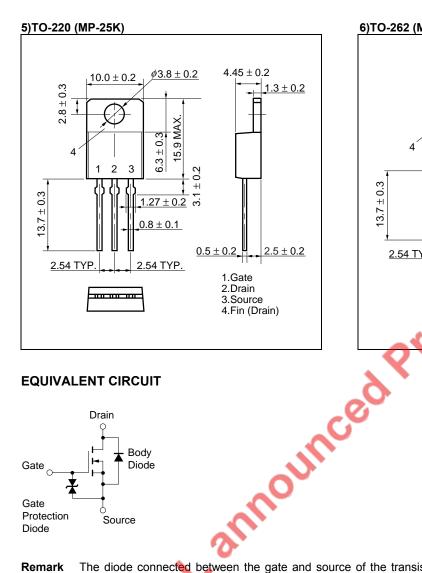


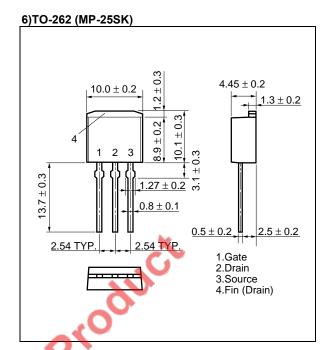




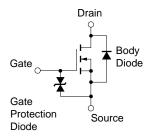


Note Not for new design





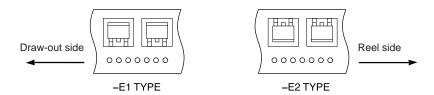
EQUIVALENT CIRCUIT



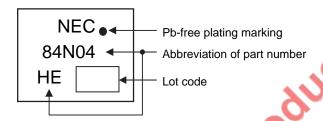
The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

<R> TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



<R> MARKING INFORMATION



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These products should be soldered and mounted under the following recommended conditions.

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For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

| Soldering Method | Soldering Conditions | Recommended Condition Symbol | |
|-------------------------|--|------------------------------|--|
| Infrared reflow | Maximum temperature (Package's surface temperature): 260°C or below | | |
| MP-25ZJ, MP-25ZK | Time at maximum temperature: 10 seconds or less | | |
| (| Time of temperature higher than 220°C: 60 seconds or less | IDC0 00 0 | |
| | Preheating time at 160 to 180°C: 60 to 120 seconds | IR60-00-3 | |
| | Maximum number of reflow processes: 3 times | | |
| | Maximum chlorine content of rosin flux (percentage mass): 0.2% or less | | |
| Wave soldering | Maximum temperature (Solder temperature): 260°C or below | | |
| MP-25, MP-25K, MP-25SK, | Time: 10 seconds or less | THDWS | |
| MP-25 Fin Cut | Maximum chlorine content of rosin flux: 0.2% (wt.) or less | | |
| Partial heating | Maximum temperature (Pin temperature): 350°C or below | | |
| MP-25ZJ, MP-25ZK, | Time (per side of the device): 3 seconds or less | P350 | |
| MP-25K, MP-25SK | Maximum chlorine content of rosin flux: 0.2% (wt.) or less | | |
| Partial heating | Maximum temperature (Pin temperature): 300°C or below | | |
| MP-25, MP-25 Fin Cut | Time (per side of the device): 3 seconds or less | P300 | |
| | Maximum chlorine content of rosin flux: 0.2% (wt.) or less | | |

Caution Do not use different soldering methods together (except for partial heating).

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